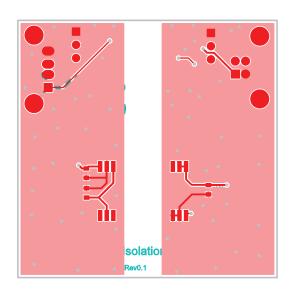
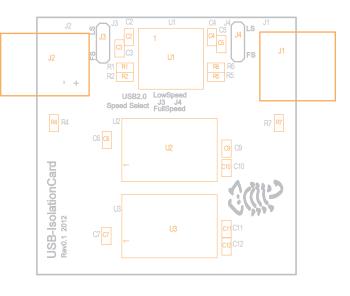
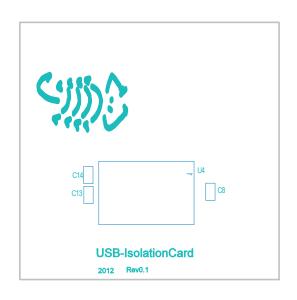


L1 S1

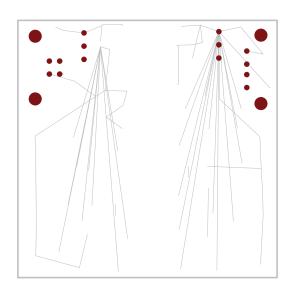




S1 TA



S2 BA



USB-IsolationCard		Copper Layer Name		Silkscreen		S Mask		P Mask		Assembly		Fab Drawing
		Тор	Bot	Тор	Bot	Top	Bot	Тор	Bot	Тор	Bot	I ab Diawing
Board No.	r0.1											FB
Date: 3/18/2012 Filename: *.pcb	Filename: *.pcb Engineer: DS		PCB Dsgnr: DS Modified Date:			3/18/2012					Software PADs v9.3	